## AFCT-5750Z and AFCT-5755Z

Families of Small Form Factor Pluggable (SFP) Optical Transceivers for Single-Mode OC12/STM-4 with Optional DMI Part of the Avago Technologies METRAK Family







### **Description**

The AFCT-575xZ family of SFP optical transceivers for OC12/STM-4 offers the customer a range of design options, including optional DMI (further described later), extended or industrial temperature ranges, and standard push-button or or bail delatch. The AFCT-5755Z family targets applications requiring DMI features, and the AFCT-5750Z family is streamlined for those applications where DMI features are not needed. Throughout this document, AFCT-575xZ will refer collectively to the entire product family encompassing this range of product features.

## **Part Number Options**

The AFCT-575xZ family consists of the following products:

#### With DMI

Part Number	Temperature	Design	Distance
AFCT-5755LZ	Extended*	Standard	SR (2km)
AFCT-5755PZ	Extended*	Bail	SR
AFCT-5755ALZ	Industrial*	Standard	SR
AFCT-5755APZ	Industrial*	Bail	SR
AFCT-5755TLZ	Extended*	Standard	IR (15km)
AFCT-5755TPZ	Extended*	Bail	IR
AFCT-5755ATLZ	Industrial*	Standard	IR
AFCT-5755ATPZ	Industrial*	Bail	IR

### Without DMI

Part Number	Temperature	Design	Distance
AFCT-5750LZ	Extended*	Standard	SR (2km)
AFCT-5750PZ	Extended*	Bail	SR
AFCT-5750ALZ	Industrial*	Standard	SR
AFCT-5750APZ	Industrial*	Bail	SR
AFCT-5750TLZ	Extended*	Standard	IR (15km)
AFCT-5750TPZ	Extended*	Bail	IR
AFCT-5750ATLZ	Industrial*	Standard	IR
AFCT-5750ATPZ	Industrial*	Bail	IR

<sup>\*</sup> Extended Temperature Range is -10 to 85 degrees C Industrial Temperature Range is -40 to 85 degrees C

## **Features**

- ROHS compliant
- · Optional Digital Diagnostic Monitoring available
  - AFCT-5750Z family: without DMI
  - AFCT-5755Z family: with DMI
- Per SFF-8472, diagnostic features on AFCT-5755Z family enable Diagnostic Monitoring Interface for optical transceivers with real-time monitoring of:
  - Transmitted optical power
  - Received optical power
  - Laser bias current
  - Temperature
  - Supply voltage
- Compliant with SFF-8074i SFP transceiver specification
- Compliant with ITU-T G957 STM-4 I-4 (2 km) and STM-4 S-4.1 (15 km)
- Compliant with Telcordia GR253 SR (2 km), IR-1 (15 km)
- Class 1 CDRH/IEC 825 eye safety compliant
- Operating case temperature range -10 °C to +85 °C (Extended)
  - -40 °C to +85 °C (Industrial)
- Multitrate operation from 155Mbps to 622Mbps
- LC duplex fiber connector
- Manufactured in an ISO 9001 compliant facility

### **Applications**

- ATM switches and routers
- SONET/SDH switch infrastructure
- Broadband aggregation applications
- Metro edge switching
- Metro and access multi-service platforms
- Suitable for Fast Ethernet applications

### **Related Products**

- AFCT-576xZ family of OC3 SFP transceivers with optional DMI
- AFCT-5745L/P family of OC48 SFP transceivers with DMI

### **General Features**

The AFCT-575xZ family of SFP optical transceivers are high performance, cost effective modules for serial optical data communications applications ranging from 155-622 Mbps. They are designed to provide SONET/SDH compliant connections for 622 Mbps at short and intermediate reach links. This includes specifications for the signal coding, optical fiber and connector types, optical and electrical transmitter characteristics, optical and electrical receiver characteristics, jitter characteristics, and compliance testing methodology for the aforementioned. These transceivers are qualified in accordance with GR-468-CORE.

The transmitter section of the SR and IR transceivers incorporate a 1300nm Fabry Perot (FP) laser. For each device the receiver section uses an MOVPE grown planar PIN photodetector for low dark current and excellent responsivity. A positive-ECL logic interface simplifies interface to external circuitry. The receiver section contains an InGaAs/InP photo detector and a preamplifier mounted in an optical subassembly. This optical subassembly is coupled to a postamplifier/decision circuit on a circuit board.

The AFCT-575xZ family of optical transceivers adds digital diagnostic monitoring to standard SFP functionality, enabling fault isolation, components monitoring and failure prediction capabilities.

## **SFP MSA Compliance**

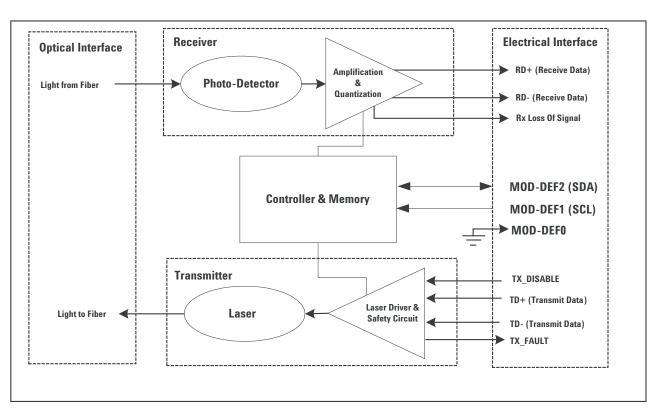
The product package is compliant with the SFP MSA with the LC connector option. The SFP MSA includes specifications for mechanical packaging and performance as well as dc, ac and control signal timing and performance.

The power supply is 3.3 V dc.

The High Speed I/O (HSIO) signal interface is a Low Voltage Differential type. It is ac coupled and terminated internally to the module. The internal termination is a 100 Ohm differential load.

### Installation

The AFCT-575xZ can be installed in any SFF-8074i compliant Small Form Pluggable (SFP) port regardless of host equipment operating status. The module is hot-pluggable, allowing it to be installed while the host system is operating and online. Upon insertion, the transceiver housing makes initial contact with the host board SFP cage, mitigating potential damage due to electrostatic discharge (ESD).



**Figure 1. Transceiver Functional Diagram** 

### **Transmitter Section**

The transmitter section includes a 1310 nm Fabry-Perot laser and a transmitter driver circuit. The driver circuit maintains a constant optical power level provided that the data pattern is valid for NRZ code. Connection to the transmitter is provided via a LC optical connector.

The transmitter has full IEC 825 and CDRH Class 1 eye safety.

### TX DISABLE

The transmitter output can be disabled by asserting pin 3, TX\_DISABLE. A high signal asserts this function while a low signal allows normal laser operation. The transmitter output can also be disabled and monitored via the 2-wire serial interface. In the event of a transceiver fault, such as the activation of the eye safety circuit, toggling of the TX\_DISABLE will reset the transmitter, as depicted in Figure 2.

### TX FAULT

A laser fault or a low V<sub>CC</sub> condition will activate the transmitter fault signal, TX\_FAULT, and disable the laser. This signal is an open collector output (pull-up required on the host board); A low signal indicates normal laser operation and a high signal indicates a fault. The TX\_FAULT will be latched high when a laser fault occurs and is cleared by toggling the TX\_DISABLE input or power cycling the transceiver. The TX\_FAULT is not latched for Low V<sub>CC</sub>. The transmitter fault condition can also be monitored via the two-wire serial interface (address A2, byte 110, bit 2). By default, TX\_FAULT is set to trigger on hardware faults only.

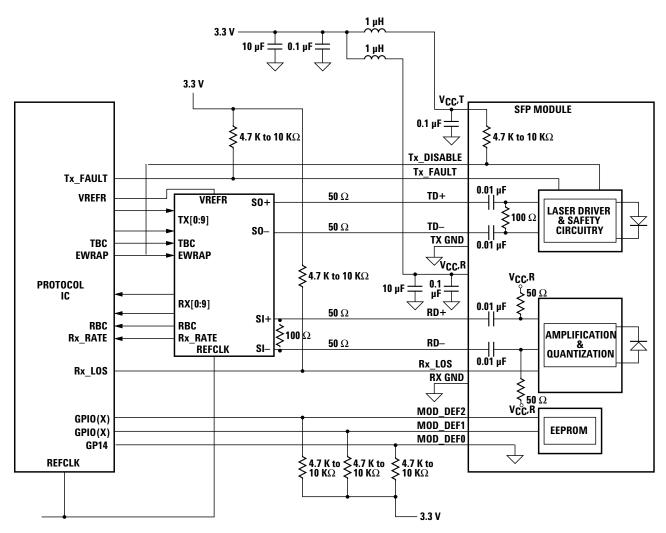


Figure 2. Typical Application Configuration

### **Receiver Section**

The receiver section for the AFCT-575xZ contains an InGaAs/InP photo detector and a preamplifier mounted in an optical subassembly. This optical subassembly is coupled to a post amplifier/decision circuit on a circuit board. The design of the optical subassembly provides better than 12 dB Optical Return Loss (ORL).

Connection to the receiver is provided via a LC optical connector.

### RX LOS

The receiver section contains a loss of signal (RX\_LOS) circuit to indicate when the optical input signal power is insufficient for SONET/SDH compliance. A high signal indicates loss of modulated signal, indicating link failure such as a broken fiber or a failed transmitter. RX\_LOS can be also be monitored via the two-wire serial (address A2, byte 110, bit 1).

### Functional Data I/O

Avago's AFCT-575xZ transceiver is designed to accept industry standard differential signals. The transceiver provides an AC-coupled, internally terminated data interface. Bias resistors and coupling capacitors have been included within the module to reduce the number of components required on the customer's board. Figure 2 illustrates the recommended interface circuit.

## **Digital Diagnostic Interface and Serial Identification**

The AFCT-575xZ family complies with the SFF-8074i specification, which defines the module's serial identification protocol to use the 2-wire serial CMOS EEPROM protocol of the ATMEL AT24C01A or similar. Standard SFP EEPROM bytes 0-255 are addressed per SFF-8074i at memory address 0xA0 (A0h).

As an enhancement to the conventional SFP interface defined in SFF-8074i, the AFCT-5755Z is also compliant to SFF-8472 (the digital diagnostic interface for SFP). This enhancement adds digital diagnostic monitoring to standard SFP functionality, enabling failure prediction, fault isolation, and component monitoring capabilities.

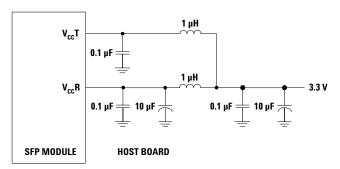


Figure 3. MSA required power supply filter

Using the 2-wire serial interface, the AFCT-5755Z provides real time access to transceiver internal supply voltage and temperature, transmitter output power, laser bias current and receiver average input power, allowing a host to predict system compliance issues. These five parameters are internally calibrated, per the MSA. New digital diagnostic information is accessed per SFF-8472 using EEPROM bytes 0-255 at memory address 0xA2 (A2h).

The digital diagnostic interface also adds the ability to disable the transmitter (TX\_DISABLE), monitor for Transmitter Faults (TX\_FAULT) and monitor for Receiver Loss of Signal (RX\_LOS).

Contents of the MSA-compliant serial ID memory are shown in Tables 3 to 7. The SFF-8074i and SFF-8472 specifications are available from the SFF Committee at http://www.sffcommittee.org.

### **Predictive Failure Identification**

The diagnostic information allows the host system to identify potential link problems. Once identified, a fail-over technique can be used to isolate and replace suspect devices before system uptime is impacted.

### **Compliance Prediction**

The real-time diagnostic parameters can be monitored to alert the system when operating limits are exceeded and compliance cannot be ensured.

### **Fault Isolation**

The diagnostic information can allow the host to pinpoint the location of a link problem and accelerate system servicing and minimize downtime.

### **Component Monitoring**

As part of the host system monitoring, the real time diagnostic information can be combined with system level monitoring to ensure system reliability.

## **Application Support**

An Evaluation Kit and Reference Designs are available to assist in evaluation of the AFCT-575xZ SFPs. Please contact your local Field Sales representative for availability and ordering details.

## **Operating Temperature**

The AFCT-575xZ family is available in either Extended (-10 to +85°C) or Industrial (-40 to +85°C) temperature ranges.

## **Power Supply Noise**

The AFCT-575xZ can withstand an injection of PSN on the V<sub>CC</sub> lines of 100 mV ac without a degradation in eye mask margin to 10% on the transmitter and a 1 dB sensitivity penalty on the receiver. This occurs when the product is used in conjunction with the MSA recommended power supply filter shown in Figure 3.

## **Regulatory Compliance**

The transceiver regulatory compliance is provided in Table 1 as a figure of merit to assist the designer. The overall equipment design will determine the certification level.

**Table 1. Regulatory Compliance** 

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883C Method 3015.4 JEDEC/EIA JESD22-A114-A	Class 2 (2000 Volts)
Electrostatic Discharge (ESD)	Bellcore GR1089-CORE	25 kV Air Discharge
to the Duplex LC Receptacle		10 Zaps at 8 kV (contact discharge) on the electrical faceplate on panel.
Electromagnetic Interference (EMI)	FCC Class B	Applications with high SFP port counts are expected to be compliant; however, margins are dependent on customer board and chassis design.
Immunity	Variation of IEC 61000-4-3	No measurable effect from a 10 V/m field swept from 80 to 1000 MHz applied to the transceiver without a chassis enclosure.
Eye Safety	US FDA CDRH AEL Class 1 EN (IEC) 60825-1, 2, EN60950 Class 1	CDRH Accession Number: 9521220-137 TUV Certificate Number: 933/21205741/040
Component Recognition	Underwriter's Laboratories and Canadian Standards Association Joint Component Recognition for Information Technology Equipment Including Electrical Business Equipment	UL file # E173874
ROHS Compliance		Reference to EU RoHS Directive 2002/95/EC

### **Electrostatic Discharge (ESD)**

There are two conditions in which immunity to ESD damage is important:

The first condition is static discharge to the transceiver during handling such as when the transceiver is inserted into the transceiver port. To protect the transceiver, it is important to use normal ESD handling precautions including the use of grounded wrist straps, work benches, and floor mats in ESD controlled areas. The ESD sensitivity of the AFCT-575xZ is compatible with typical industry production environments.

The second condition is static discharge to the exterior of the host equipment chassis after installation. To the extent that the duplex LC optical interface is exposed to the outside of the host equipment chassis, it may be subject to system-level ESD requirements. The ESD performance of the AFCT-575xZ exceeds typical industry standards. Table 1 documents ESD immunity to both of these conditions.

## Electromagnetic Interference (EMI)

Most equipment designs using the AFCT-575xZ SFPs are subject to the requirements of the FCC in the United States, CENELEC EN55022 (CISPR 22) in Europe and VCCI in Japan. The metal housing and shielded design of the transceiver minimize EMI and provide excellent EMI performance.

## **EMI Immunity**

The AFCT-575xZ transceivers have a shielded design to provide excellent immunity to radio frequency electromagnetic fields which may be present in some operating environments.

## **Eye Safety**

The AFCT-575xZ transceivers provide Class 1 eye safety by design. Avago Technologies has tested the transceiver design for regulatory compliance, under normal operating conditions and under a single fault condition. See Table 1.

### **Flammability**

The AFCT-575xZ family of SFPs is compliant to UL 94V-0.

## **Customer Manufacturing Processes**

This module is pluggable and is not designed for aqueous wash, IR reflow, or wave soldering processes.

### **Caution**

The AFCT-575xZ contains no user-serviceable parts. Tampering with or modifying the performance of the AFCT-575xZ will result in voided product warranty. It may also result in improper operation of the transceiver circuitry, and possible over-stress of the laser source. Device degradation or product failure may result. Connection of the AFCT-575xZ to a non-approved optical source, operating above the recommended absolute maximum conditions may be considered an act of modifying or manufacturing a laser product. The person(s) performing such an act is required by law to re-certify and re-identify the laser product under the provisions of U.S. 21 CF.

## **Handling Precautions**

The AFCT-575xZ can be damaged by current surges or overvoltage. Power supply transient precautions should be taken, and normal handling precautions for electrostatic sensitive devices should be taken.

## **Optical Power Budget**

The worst-case Optical Power Budget (OPB) in dB for a fiber-optic link is determined by the difference between the minimum transmitter output optical power (dBm avg) and the lowest receiver sensitivity (dBm avg). This OPB provides the necessary optical signal range to establish a working fiber-optic link. The OPB is allocated for the fiber-optic cable length and the corresponding link penalties. For proper link performance, all penalties that affect the link performance must be accounted for within the link optical power budget.

### **Process Plug**

This transceiver is supplied with a process plug for protection of the optical port within the LC connector receptacle. This process plug prevents contamination during handling, shipping and storage. It is made of a high-temperature, molded sealing material that can withstand +85 °C.

### **LC SFP Cleaning Recommendations**

In the event of contamination of the optical ports, the recommended cleaning process is the use of forced nitrogen. If contamination is thought to have remained, the optical ports can be cleaned using a NTT international Cletop stick type (diam. 1.25 mm) and HFE7100 cleaning fluid.

**Table 2. Pin description** 

Pin	Name	Function/Description	MSA Notes
1	VeeT	Transmitter Ground	,
2	TX Fault	Transmitter Fault Indication	Note 1
3	TX Disable	Transmitter Disable - Module disables on high or open	Note 2
4	MOD-DEF2	Module Definition 2 - Two wire serial ID interface	Note 3
5	MOD-DEF1	Module Definition 1 - Two wire serial ID interface	Note 3
6	MOD-DEF0	Module Definition 0 - Grounded in module	Note 3
7	Rate Select	Not Connected	
8	LOS	Loss of Signal	Note 4
9	VeeR	Receiver Ground	
10	VeeR	Receiver Ground	
11	VeeR	Receiver Ground	
12	RD-	Inverse Received Data Out	Note 5
13	RD+	Received Data Out	Note 5
14	VeeR	Receiver Ground	
15	VccR	Receiver Power - 3.3 V ±5%	Note 6
16	VccT	Transmitter Power - 3.3 V ±5%	Note 6
17	VeeT	Transmitter Ground	
18	TD+	Transmitter Data In	Note 7
19	TD-	Inverse Transmitter Data In	Note 7
20	VeeT	Transmitter Ground	

#### Notes:

- 1. TX Fault is an open collector/drain output, which should be pulled up with a  $4.7K 10K\Omega$  resistor on the host board. Pull up voltage between 2.0 V and VccT, R+0.3 V. When high, output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8 V. By default, TX\_FAULT is set to trigger on hardware faults only.
- 2. TX Disable input is used to shut down the laser output per the state table below with an external  $4.7 10 \, \mathrm{K}\Omega$  pull-up resistor.

Low (0 - 0.8 V): Transmitter on

Between (0.8 V and 2.0 V): Undefined

High (2.0 - 3.465 V): Transmitter Disabled

Open: Transmitter Disabled

- 3. MOD-DEF 0,1,2. These are the module definition pins. They should be pulled up with a 4.7 10 K $\Omega$  resistor on the host board to a supply less than VccT +0.3 V or VccR+0.3 V.
  - MOD-DEF 0 is grounded by the module to indicate that the module is present

MOD-DEF 1 is clock line of two wire serial interface for optional serial ID

MOD-DEF 2 is data line of two wire serial interface for optional serial ID

- 4. LOS (Loss of Signal) is an open collector/drain output which should be pulled up externally with a  $4.7K 10 \text{ K}\Omega$  resistor on the host board to a supply < VccT,R+0.3 V. When high, this output indicates the received optical power is below the worst case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8 V.
- 5. RD-/+: These are the differential receiver outputs. They are ac coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  differential at the user SERDES. The ac coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 500 and 2000 mV differential (250 1000 mV single ended) when properly terminated.
- 6. VccR and VccT are the receiver and transmitter power supplies. They are defined as 3.135 3.465 V at the SFP connector pin. The maximum supply current is 250 mA and the associated inrush current will be no more than 30 mA above steady state after 500 nanoseconds.
- 7. TD-/+: These are the differential transmitter inputs. They are ac coupled differential lines with  $100\Omega$  differential termination inside the module. The ac coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500 2400 mV (250 1200 mV single ended), though it is recommended that values between 500 and 1200 mV differential (250 600 mV single ended) be used for best EMI performance.

Table 3. EEPROM Serial ID Memory Contents - Address A0h

10 00 37 00 Hex Byte of 64 00 Vendor OUI¹  11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI¹  12 02 155 Mbit/sec nominal bit rate 9 40 41 A 67 00 Lower Bit F  14 Table Link length 9 μm in 41 46 F 68-83 Vendor Special Scramble 10 10 10 10 10 10 10 10 10 10 10 10 10	
Dot	
3	
4       Table 4       SONET Reach Specifier 31       20       58       31         5       Table 5ONET Compliance 4 Code       32       20       59       30         6       00       33       20       60       Table 4         7       00       34       20       61       Table 4         8       00       35       20       62       00         9       00       36       00       63       Checksum         10       00       37       00       Hex Byte of Vendor OUI¹       64       00         11       05       SONET Scrambled       38       17       Hex Byte of Vendor OUI¹       65       1A       Hardware Tx_Fault & Vendor OUI¹         12       02       155 Mbit/sec nominal bit rate       39       6A       Hex Byte of Vendor OUI¹       66       00       Upper Bit Mark Py Link length 9 Link len	
4 5 Table SONET Compliance 32 20 59 30 6 00 33 20 60 Table 4 7 00 34 20 61 Table 4 8 00 35 20 62 00 9 00 36 00 63 Checksum 10 00 37 00 Hex Byte of Vendor OUI¹ 11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI¹ 11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI¹ 12 02 155 Mbit/sec nominal bit rate 40 41 A 67 00 Lower Bit File 14 Table Link length 9 μm in 41 46 F 68-83 Vendor Sp ber ASCII of A table Link length 9 μm in 42 43 C 84-91 Vendor Da characters	
4 Code 6 00 33 20 60 Table 4 7 00 34 20 61 Table 4 8 00 35 20 62 00 9 00 36 00 63 Checksum 10 00 37 00 Hex Byte of Vendor OUI <sup>1</sup> 64 00 11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI <sup>1</sup> Tx_Fault & Vendor OUI <sup>1</sup> 12 02 155 Mbit/sec nominal bit rate 9 6A Hex Byte of Vendor OUI <sup>1</sup> 66 00 Upper Bit Follows 13 00 40 41 A 67 00 Lower Bit Follows 14 km 42 43 C 84-91 Vendor Da Characters	
7       00       34       20       61       Table 4         8       00       35       20       62       00         9       00       36       00       63       Checksum         10       00       37       00       Hex Byte of Vendor OUI¹       64       00         11       05       SONET Scrambled       38       17       Hex Byte of Vendor OUI¹       65       1A       Hardware Tx_Fault & H	
8       00       35       20       62       00         9       00       36       00       63       Checksum         10       00       37       00       Hex Byte of Vendor OUI¹       64       00         11       05       SONET Scrambled       38       17       Hex Byte of Vendor OUI¹       65       1A       Hardware Tx_Fault & Vendor OUI¹         12       02       155 Mbit/sec nominal bit rate       39       6A       Hex Byte of Vendor OUI¹       66       00       Upper Bit Fendor OUI¹         13       00       40       41       A       67       00       Lower Bit Fendor Special Control of Characters         14       Table Link length 9 μm in 41       46       F       68-83       Vendor Special Control of Characters         15       Table Link length 9 μm in 42       43       C       84-91       Vendor Da Characters	
9 00 36 00 63 Checksum  10 00 37 00 Hex Byte of Vendor OUI¹  11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI¹  12 02 155 Mbit/sec nominal bit rate 39 6A Hex Byte of Vendor OUI¹  13 00 40 41 A 67 00 Lower Bit For ASCII of Amount of Amount of Association (Amount of Association) and A	
10 00 37 00 Hex Byte of 64 00 Vendor OUI¹  11 05 SONET Scrambled 38 17 Hex Byte of Vendor OUI¹  12 02 155 Mbit/sec nominal 39 6A Hex Byte of Vendor OUI¹  13 00 40 41 A 67 00 Lower Bit For For Scramble A km  14 Table Link length 9 μm in 41 46 F 68-83 Vendor Specific A km  15 Table Link length 9 μm in 42 43 C 84-91 Vendor Dacharacters	
Vendor OUI¹           11         05         SONET Scrambled         38         17         Hex Byte of Vendor OUI¹         65         1A         Hardware Straight & Hardware	for Bytes 0-62 <sup>3</sup>
Vendor OUI¹       Tx_Fault &         12       02       155 Mbit/sec nominal bit rate       39       6A       Hex Byte of Vendor OUI¹       66       00       Upper Bit Feature         13       00       40       41       A       67       00       Lower Bit Feature         14       Table Link length 9 μm in 41       46       F       68-83       Vendor Spectral ber ASCII of Vendor Date of Characters         15       Table Link length 9 μm in m 42       43       C       84-91       Vendor Date of Characters	
bit rate       Vendor OUI¹         13       00       40       41       A       67       00       Lower Bit F         14       Table 4 km       41       46       F       68-83       Vendor Sp ber ASCII of ber ASCII	SFP Tx_Disable, Rx_LOS
14 Table Link length 9 μm in 41 46 F 68-83 Vendor Sp. ber ASCII c  15 Table Link length 9 μm in m 42 43 C 84-91 Vendor Da characters	Rate Margin
4 km ber ASCII c  15 Table Link length 9 μm in m 42 43 C 84-91 Vendor Da  4 Characters	Rate Margin
4 characters	ecific Serial Num- haracters <sup>4</sup>
16 00 43 54 T 92 Table 4	te Code ASCII
17 00 44 2D - 93 Table 4	
18 00 45 35 5 94 Table 4	
19 00 46 37 7 95 Checksum	for Bytes 64-94 <sup>3</sup>
20 41 A 47 35 5 96-127 00 Vendor spe	ecific EEPROM
21 56 V 48 Table 4 128- 00 Reserved 255	
22 41 A 49 Table 4	
23 47 G 50 Table 4	
24 4F O 51 Table 4	
25 20 52 Table 4	
26 20 53 20	

- 1. The IEEE Organizationally Unique Identifier (OUI) assigned to Avago is 00-17-6A (3 bytes of hex).
- 2. Laser wavelength is represented in 16 unsigned bits.
- 3. Addresses 63 and 95 are checksums calculated (per SFF-8472 and SFF-8074) and stored prior to product shipment.
- 4. Addresses 68-83 specify the ASCII serial number and will vary on a per unit basis.
- 5. Addresses 84-91 specify the ASCII date code and will vary on a per date code basis.

**Table 4a. Individual Identifiers** 

Byte#	Hex	Notes	Hex	Notes	Hex	Notes	Hex	Notes
	AFCT-5750LZ		AFCT-5750PZ		AFCT-5750TLZ		AFCT-5750TPZ	
4	10	SR-1	10	SR-1	10	IR-1	10	IR-1
5	10	OC-12 SR-1	10	OC-12 SR-1	20	OC-12 IR-1	20	OC-12 IR-1
14	02	2 Km	02	2 Km	0F	15 Km	0F	15 Km
15	14	2000m	14	2000m	96	15000m	96	15000m
48	30	0	30	0	30	0	30	0
49	4C	L	50	Р	54	T	54	T
50	5A	Z	5A	Z	4C	L	50	Р
51	20	-	20	-	5A	Z	5A	Z
52	20	-	20	-	20	-	20	-
60	05	1310nm	05	1310nm	05	1310nm	05	1310nm
61	1E		1E		1E		1E	
92	00		00		00		00	
93	00		00		00		00	
94	00		00		00		00	
	AFCT-5750ALZ		AFCT-5750APZ	!	AFCT-5750ATLZ	!	AFCT-5750ATP	7
4	10	SR-1	10	SR-1	10	IR-1	10	IR-1
5	10	OC-12 SR-1	10	OC-12 SR-1	20	OC-12 IR-1	20	OC-12 IR-1
14	02	2 Km	02	2 Km	0F	15 Km	0F	15 Km
15	14	2000m	14	2000m	96	15000m	96	15000m
48	30	0	30	0	30	0	30	0
49	41	А	41	А	41	A	41	А
50	4C	L	50	Р	54	Т	54	T
51	5A	Z	5A	Z	4C	L	50	Р
52	20	-	20	-	5A	Z	5A	Z
60	05	1310nm	05	1310nm	05	1310nm	05	1310nm
61	1E		1E		1E		1E	
92	00		00		00		00	
93	00		00		00		00	
94	00		00		00		00	

Table 4b. Individual Identifiers cont.

Byte#	Hex	Notes	Hex	Notes	Hex	Notes	Hex	Notes
	AFCT-5755LZ		AFCT-5755PZ		AFCT-5755TLZ		AFCT-5755TPZ	
4	10	SR-1	10	SR-1	10	IR-1	10	IR-1
5	10	OC-12 SR-1	10	OC-12 SR-1	20	OC-12 IR-1	20	OC-12 IR-1
14	02	2 Km	02	2 Km	0F	15 Km	0F	15 Km
15	14	2000m	14	2000m	96	15000m	96	15000m
48	35	5	35	5	35	5	35	5
49	4C	L	50	Р	54	Т	54	Т
50	5A	Z	5A	Z	4C	L	50	Р
51	20	-	20	-	5A	Z	5A	Z
52	20	-	20	-	20	-	20	-
60	05	1310nm	05	1310nm	05	1310nm	05	1310nm
61	1E		1E		1E		1E	
92	68		68		68		68	
93	F0		F0		F0		F0	
94	01		01		01		01	
	AFCT-5755ALZ		AFCT-5755APZ		AFCT-5755ATLZ	7	AFCT-5755ATP	Z
4	10	SR-1	10	SR-1	10	IR-1	10	IR-1
5	10	OC-12 SR-1	10	OC-12 SR-1	20	OC-12 IR-1	20	OC-12 IR-1
14	02	2 Km	02	2 Km	0F	15 Km	0F	15 Km
15	14	2000m	14	2000m	96	15000m	96	15000m
48	35	5	35	5	35	5	35	5
49	41	А	41	Α	41	Α	41	Α
50	4C	L	50	Р	54	Т	54	Т
51	5A	Z	5A	Z	4C	L	50	Р
52	20	-	20	-	5A	Z	5A	Z
60	05	1310nm	05	1310nm	05	1310nm	05	1310nm
61	1E		1E		1E		1E	
92	68		68		68		68	
93	F0		F0		F0		F0	
94	01		01		01		01	

Table 5. EEPROM Serial ID Memory Contents - Address A2h (AFCT-5755Z family only)

Byte# Decimal	Notes	Byte # Decimal	Notes	Byte # Decimal	Notes
0	Temp H Alarm MSB <sup>1</sup>	26	Tx Pwr L Alarm MSB <sup>4</sup>	104	Real Time Rx P <sub>AV</sub> MSB <sup>5</sup>
1	Temp H Alarm LSB <sup>1</sup>	27	Tx Pwr L Alarm LSB <sup>4</sup>	105	Real Time Rx P <sub>AV</sub> LSB <sup>5</sup>
2	Temp L Alarm MSB <sup>1</sup>	28	Tx Pwr H Warning MSB <sup>4</sup>	106	Reserved
3	Temp L Alarm LSB <sup>1</sup>	29	Tx Pwr H Warning LSB <sup>4</sup>	107	Reserved
4	Temp H Warning MSB <sup>1</sup>	30	Tx Pwr L Warning MSB <sup>4</sup>	108	Reserved
5	Temp H Warning LSB <sup>1</sup>	31	Tx Pwr L Warning LSB <sup>4</sup>	109	Reserved
6	Temp L Warning MSB <sup>1</sup>	32	Rx Pwr H Alarm MSB <sup>5</sup>	110	Status/Control - see Table 6
7	Temp L Warning LSB <sup>1</sup>	33	Rx Pwr H Alarm LSB <sup>5</sup>	111	Reserved
8	V <sub>CC</sub> H Alarm MSB <sup>2</sup>	34	Rx Pwr L Alarm MSB <sup>5</sup>	112	Flag Bits - see Table 7
9	V <sub>CC</sub> H Alarm LSB <sup>2</sup>	35	Rx Pwr L Alarm LSB <sup>5</sup>	113	Flag Bit - see Table 7
10	V <sub>CC</sub> L Alarm MSB <sup>2</sup>	36	Rx Pwr H Warning MSB <sup>5</sup>	114	Reserved
11	V <sub>CC</sub> L Alarm LSB <sup>2</sup>	37	Rx Pwr H Warning LSB <sup>5</sup>	115	Reserved
12	V <sub>CC</sub> H Warning MSB <sup>2</sup>	38	Rx Pwr L Warning MSB <sup>5</sup>	116	Flag Bits - see Table 7
13	V <sub>CC</sub> H Warning LSB <sup>2</sup>	39	Rx Pwr L Warning LSB <sup>5</sup>	117	Flag Bits - see Table 7
14	V <sub>CC</sub> L Warning MSB <sup>2</sup>	40-55	Reserved	118	Reserved
15	V <sub>CC</sub> L Warning LSB <sup>2</sup>	56-94	External Calibration Constants <sup>6</sup>	119	Reserved
16	Tx Bias H Alarm MSB <sup>3</sup>	95	Checksum for Bytes 0-94 <sup>7</sup>	120-122	Reserved
17	Tx Bias H Alarm LSB <sup>3</sup>	96	Real Time Temperature MSB <sup>1</sup>	123	
18	Tx Bias L Alarm MSB <sup>3</sup>	97	Real Time Temperature LSB <sup>1</sup>	124	
19	Tx Bias L Alarm LSB <sup>3</sup>	98	Real Time Vcc MSB <sup>2</sup>	125	
20	Tx Bias H Warning MSB <sup>3</sup>	99	Real Time Vcc LSB <sup>2</sup>	126	
21	Tx Bias H Warning LSB <sup>3</sup>	100	Real Time Tx Bias MSB <sup>3</sup>	127	Reserved <sup>8</sup>
22	Tx Bias L Warning MSB <sup>3</sup>	101	Real Time Tx Bias LSB <sup>3</sup>	128-247	Customer Writable <sup>9</sup>
23	Tx Bias L Warning LSB <sup>3</sup>	102	Real Time Tx Power MSB <sup>4</sup>	248-254	Vendor Specific
24	Tx Pwr H Alarm MSB <sup>4</sup>	103	Real Time Tx Power LSB <sup>4</sup>	255	
25	Tx Pwr H Alarm LSB <sup>4</sup>				

- 1. Temperature (Temp) is decoded as a 16 bit signed twos compliment integer in increments of 1/256  $\,^{\circ}$ C.
- 2. Supply voltage (V $_{CC)}$  is decoded as a 16 bit unsigned integer in increments of 100  $\mu V\!.$
- 3. Laser bias current (Tx Bias) is decoded as a 16 bit unsigned integer in increments of 2  $\mu A$ .
- 4. Transmitted average optical power (Tx Pwr) is decoded as a 16 bit unsigned integer in increments of 0.1 μW.
- 5. Received average optical power (Rx Pwr) is decoded as a 16 bit unsigned integer in increments of 0.1  $\mu$ W.
- 6. Bytes 55-94 are not intended from use with AFCT-5755xxxx, but have been set to default values per SFF-8472.
- 7. Bytes 95 is a checksum calculated (per SFF-8472) and stored prior to product shipment.
- 8. Byte 127 accepts a write but performs no action (reserved legacy byte).
- 9. Bytes 128-247 are write enabled (customer writable).
- 10. Byte 255 bits 2 and 3 control laser margining (per Table 7) when an enabling password is entered into bytes 123-126.

Table 6. EEPROM Serial ID Memory Contents - Address A2h, Byte 110 (AFCT-5755Z family only)

Bit #	Status/Control Name	Description
7	Tx Disable State	Digital state of SFP Tx Disable Input Pin (1 = $Tx$ _ Disable asserted)
6	Soft Tx Disable	Read/write bit for changing digital state of SFP Tx_Disable function <sup>1</sup>
5	Reserved	
4	Rx Rate Select State	Digital state of SFP Rate Select Input Pin (1 = full bandwidth of 622 Mbit) $^2$
3	Reserved	
2	Tx Fault State	Digital state of the SFP Tx Fault Output Pin (1 = Tx Fault asserted) $^3$
1	Rx LOS State	Digital state of the SFP LOS Output Pin (1 = LOS asserted)
0	Data Ready (Bar)	Indicates transceiver is powered and real time sense data is ready (0 = Ready)

- 1. Bit 6 is logic OR'd with the SFP Tx\_Disable input pin 3 ... either asserted will disable the SFP transmitter.
- 2. AFCT-5755Z does not respond to state changes on Rate Select Input Pin. It is internally hardwired to full bandwidth.
- 3. By default, TX\_FAULT is set to trigger on hardware faults only.

Table 7. EEPROM Serial ID Memory Contents - Address A2h, Bytes 112, 113, 116, 117 (AFCT-5755Z family only)

Byte	Bit#	Flag Bit Name	Description
112	7	Temp High Alarm	Set when transceiver nternal temperature exceeds high alarm threshold.
	6	Temp Low Alarm	Set when transceiver internal temperature exceeds alarm threshold.
	5	V <sub>CC</sub> High Alarm	Set when transceiver internal supply voltage exceeds high alarm threshold.
	4	V <sub>CC</sub> Low Alarm	Set when transceiver internal supply voltage exceeds low alarm threshold.
	3	Tx Bias High Alarm	Set when transceiver laser bias current exceeds high alarm threshold.
	2	Tx Bias Low Alarm	Set when transceiver laser bias current exceeds low alarm threshold.
	1	Tx Power High Alarm	Set when transmitted average optical power exceeds high alarm threshold.
	0	Tx Power Low Alarm	Set when transmitted average optical power exceeds low alarm threshold.
113	7	Rx Power High Alarm	Set when received P_Avg optical power exceeds high alarm threshold.
	6	Rx Power Low Alarm	Set when received P_Avg optical power exceeds low alarm threshold.
-	0-5	Reserved	
116	7	Temp High Warning	Set when transceiver internal temperature exceeds high warning threshold.
	6	Temp Low Warning	Set when transceiver internal temperature exceeds low warning threshold.
	5	V <sub>CC</sub> High Warning	Set when transceiver internal supply voltage exceeds high warning threshold.
	4	V <sub>CC</sub> Low Warning	Set when transceiver internal supply voltage exceeds low warning threshold.
	3	Tx Bias High Warning	Set when transceiver laser bias current exceeds high warning threshold.
	2	Tx Bias Low Warning	Set when transceiver laser bias current exceeds low warning threshold.
	1	Tx Power High Warning	Set when transmitted average optical power exceeds high warning threshold.
	0	Tx Power Low Warning	Set when transmitted average optical power exceeds low warning threshold.
117	7	Rx Power High Warning	Set when received P_Avg optical power exceeds high warning threshold.
	9	Rx Power Low Warning	Set when received P_Avg optical power exceeds low warning threshold.
	0-5	Reserved	

## **Optical Parameters**

## **Absolute Maximum Ratings**

Absolute maximum ratings are those values beyond which functional performance is not intended, device reliability is not implied, and damage to the device may occur.

Parameter	Symbol	Minimum	Maximum	Unit	Notes
Storage Temperature (non-operating)	Ts	-40	+85	°C	
Relative Humidity	RH	0	85	%	
Supply Voltage	V <sub>CC</sub>	-0.5	3.63	V	
Input Voltage on any Pin	VI	-0.5	V <sub>C</sub> C	V	
Receiver Optical Input	P <sub>IN</sub> ABS		0	dBm	

## **Recommended Multirate Operating Conditions**

Typical operating conditions are those values for which functional performance and device reliability is implied.

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Case Operating Temperature						
AFCT-575xLZ/PZ/TLZ/TPZ	$T_C$	-10		+85	°C	
AFCT-575xALZ/APZ/ATLZ/ATPZ	$T_C$	-40		+85	°C	
Supply Voltage	V <sub>C</sub> C	3.1	3.3	3.5	V	

## Transceiver Electrical Characteristics for multirate operations at OC-3 (155 Mbps) and OC-12 (622 Mbps)

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Module supply current	I <sub>CCT</sub>			250	mA	1
Power Dissipation	P <sub>DISS</sub>			875	mW	
AC Electrical Characteristics						
Power Supply Noise Rejection	PSNR	100			mV	2
DC Electrical Characteristics						
Signal Outputs:	V <sub>OH</sub>	2.0		3.5	V	3
Transmit Fault (TX_FAULT)Loss of Signal (LOS)	V <sub>OL</sub>	0		0.8	V	
Signal Inputs:	V <sub>IH</sub>	2.0		3.5	V	6
Transmitter Disable (TX_DISABLE)MOD-DEF1, 2	V <sub>IL</sub>	0		0.8	V	
Data Input:						
Transmitter Single Ended Input Voltage (TD±)	VI	250		1200	mV	4
Data Ouput:						
Receiver Single Ended Output Voltage (RD±)	V <sub>O</sub>	250		1000	mV	5

- 1. MSA gives max current at 300 mA.
- 2. MSA filter is required on host board 10 Hz to 2 MHz.
- 3. LVTTL, External 4.7-10 K $\Omega$  pull up resistor required on host board to voltage less than Vcc + 0.3 V.
- 4. Internally ac coupled and terminated (100  $\Omega$  differential).
- 5. Internally ac coupled and load termination located at the user SERDES.
- 6. Minimum input to MOD-DEF1,2 is  $0.7*V_{CC}$

## Transmitter Optical Characteristics for multirate operations at OC-3 (155 Mbps) and OC-12 (622 Mbps)

Parameter		Symbol	Minimum	Typical*	Maximum	Unit	Notes
Optical Output Power	AFCT-575xLZ/PZ/ALZ/APZ	Pout	-15		-8	dBm	1
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	Pout	-15		-8	dBm	1
Center Wavelength	AFCT-575xLZ/PZ/ALZ/APZ	λς	1261		1360	nm	
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	λς	1274		1356	nm	
Spectral Width - RMS	AFCT-575xLZ/PZ/ALZ/APZ	σ			14.5	nm	2
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	σ			2.5	nm	2
Optical Rise Time		t <sub>r</sub>			400	ns	3
Optical Fall Time		t <sub>f</sub>			400	ns	3
Tx disable OFF power		P <sub>OFF</sub>			-45	dBm	
Extinction Ratio	AFCT-575xLZ/PZ/ALZ/APZ	Er	8.2			dB	
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	Er	8.2			dB	
Eye Mask Margin		EMM	30			%	4
Jitter Generation		pk to pk			70	mUI	5
		RMS			7	mUI	5

<sup>\*</sup>Typicals indicated expected values for room temperature measurements +25  $^{\circ}\text{C}$ 

#### Notes

- 1. The output power is coupled into a 1 m single mode fiber. Minimum output optical level is at end of life
- 2. The relationship between FWHM and RMS values for spectral width can derived from the Gaussian shaped spectrum which results in RMS=FWHM/2.35
- 3. These are unfiltered 20-80% values.
- 4. 30% margin to eye mask in Telcordia GR-253-CORE and ITU-T G.957
- 5. Jitter measurements taken with Agilent Technologies OMNIBER 718 in accordance with GR253

## Receiver Optical Characteristics for multirate operations at OC-3 (155 Mbps) and OC-12 (622 Mbps)

Parameter		Symbol	Minimum	Typical	Maximum	Unit	Notes
Receiver Sensitivity	AFCT-575xLZ/PZ/ALZ/APZ	P <sub>IN</sub> MIN			-23	dBm	1
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	P <sub>IN</sub> MIN			-28	dBm	1
Receiver Overload		$P_{IN}MAX$	-8			dBm	
Input Operating Waveler	ngth		1261		1360	nm	
LOS Deassert	AFCT-575xLZ/PZ/ALZ/APZ	P <sub>LOSD</sub>			-23.5	dBm	
	AFCT-575xTLZ/TPZ/ATLZ/ATPZ	P <sub>LOSD</sub>			-28.5	dBm	
LOS Assert		P <sub>LOSA</sub>	-45			dBm	
LOS Hysteresis		P <sub>H</sub>	0.5		4	dB	

<sup>1.</sup> The receiver is guaranteed to provide output data with a Bit Error Rate better than or equal to 1 x 10<sup>-10</sup> measured with TX powered and carrying

## Transceiver Digital Diagnostic Monitor (Real Time Sense) Characteristics (AFCT-5755Z family only)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Reference
Transceiver Internal Temperature Accuracy	T <sub>INT</sub>	-3.0		+3.0	°C	1
Transceiver Internal Supply Voltage Accuracy	$V_{INT}$	-3.0		+3.0	%	2
Transmitter Laser dc Bias Current Accuracy	I <sub>INT</sub>	-10		+10	%	3
Transmitted Average Optical Output Power Accuracy	$P_{T}$	-3.0		+3.0	dB	
Received Average Optical Input Power Accuracy	PR	-3.0		+3.0	dB	

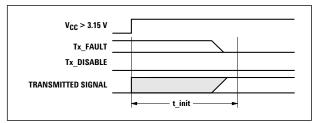
### Notes:

- 1. Temperature was measured internal to the transceiver. Valid from = -10 °C to +85 °C or from -40 °C to +85 °C. For calibration to an external temperature, please contact Avago Technologies.
- 2. Reference voltage is 3.3 V.
- 3. Valid from 0 to 50 mA, avg.

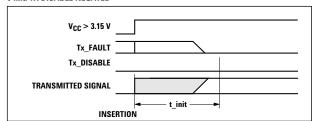
### **Transceiver Timing Characteristics**

Symbol	Minimum	Maximum	Unit	Notes
t_off		10	ms	Note 1
t_on		1	ms	Note 2
t_init		300	ms	Note 3
t_fault		100	ms	Note 4
t_reset	10		ms	Note 5
t_loss_on		100	ms	Note 6
t_loss_off		100	ms	Note 7
t_off_soft		100	ms	Note 8
t_on_soft		100	ms	Note 9
t_fault_soft		100	ms	Note 10
t_loss_on_soft		100	ms	Note 11
t_loss_off_soft		100	ms	Note 12
t_data		1000	ms	Note 13
t_serial		300	ms	Note 14
t_write		10	ms	Note 15
f_serial_clock		400	kHz	
	t_off  t_on  t_init  t_fault  t_reset  t_loss_on  t_loss_off  t_off_soft  t_on_soft  t_fault_soft  t_loss_on_soft  t_loss_off_soft  t_loss_off_soft  t_data  t_serial  t_write	t_off  t_on  t_init  t_fault  t_reset 10  t_loss_on  t_loss_off  t_off_soft  t_on_soft  t_fault_soft  t_loss_on_soft  t_loss_off_soft  t_loss_off_soft  t_data  t_serial  t_write	t_off       10         t_on       1         t_init       300         t_fault       100         t_reset       10         t_loss_on       100         t_off_soft       100         t_on_soft       100         t_fault_soft       100         t_loss_on_soft       100         t_loss_off_soft       100         t_data       1000         t_serial       300         t_write       10	t_off       10       ms         t_on       1       ms         t_init       300       ms         t_fault       100       ms         t_reset       10       ms         t_loss_on       100       ms         t_off_soft       100       ms         t_on_soft       100       ms         t_fault_soft       100       ms         t_loss_on_soft       100       ms         t_loss_off_soft       100       ms         t_data       1000       ms         t_serial       300       ms         t_write       10       ms

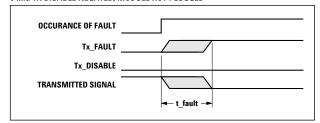
- $1. \ \ \, \text{Time from rising edge of TX\_DISABLE to when the optical output falls below 10\% of nominal.}$
- 2. Time from falling edge of TX\_DISABLE to when the modulated optical output rises above 90% of nominal.
- 3. Time from power on or falling edge of Tx\_Disable to when the modulated optical output rises above 90% of nominal.
- ${\bf 4.} \quad From \ power \ on \ or \ negation \ of \ TX\_FAULT \ using \ TX\_DISABLE.$
- $5. \ \ \, \text{Time TX\_DISABLE must be held high to reset the laser fault shutdown circuitry.}$
- 6. Time from loss of optical signal to Rx\_LOS Assertion.
- 7. Time from valid optical signal to Rx\_LOS De-Assertion.
- 8. Time from two-wire interface assertion of TX\_DISABLE (A2h, byte 110, bit 6) to when the optical output falls below 10% of nominal. Measured from falling clock edge after stop bit of write transaction.
- 9. Time from two-wire interface de-assertion of TX\_DISABLE (A2h, byte 110, bit 6) to when the modulated optical output rises above 90% of nominal.
- 10. Time from fault to two-wire interface TX\_FAULT (A2h, byte 110, bit 2) asserted.
- 11. Time for two-wire interface assertion of Rx\_LOS (A2h, byte 110, bit 1) from loss of optical signal.
- $12. Time for two-wire interface de-assertion of Rx\_LOS (A2h, byte 110, bit 1) from presence of valid optical signal. \\$
- 13. From power on to data ready bit asserted (A2h, byte 110, bit 0). Data ready indicates analog monitoring circuitry is functional.
- 14. Time from power on until module is ready for data transmission over the serial bus (reads or writes over A0h and A2h).
- 15. Time from stop bit to completion of a 1-8 byte write command.



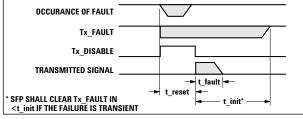
### t-init: TX DISABLE NEGATED



### t-init: TX DISABLE NEGATED, MODULE HOT PLUGGED

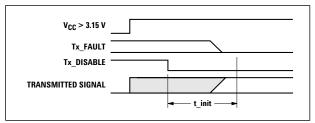


### t-fault: TX FAULT ASSERTED, TX SIGNAL NOT RECOVERED

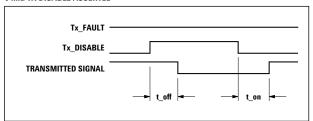


t-fault: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL NOT RECOVERED

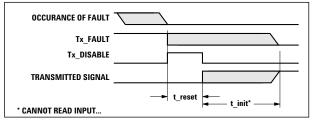
**Figure 5. Timing Diagrams** 



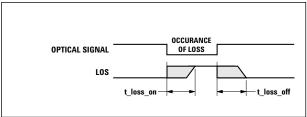
### t-init: TX DISABLE ASSERTED



### t-off & t-on: TX DISABLE ASSERTED THEN NEGATED



### t-reset: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL RECOVERED



t-loss-on & t-loss-off

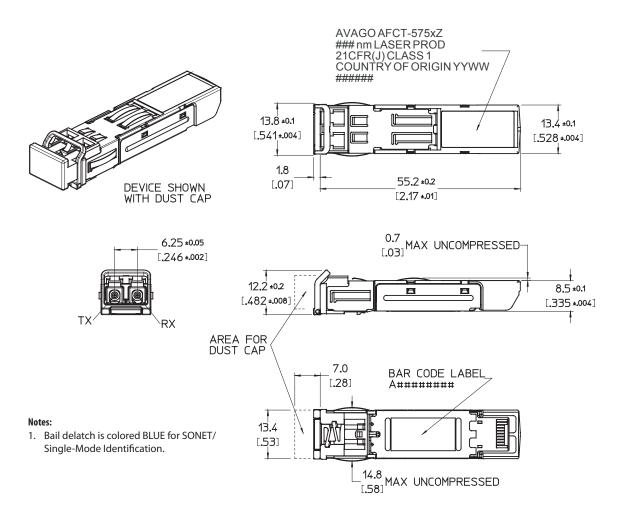


Figure 6. Module Drawing

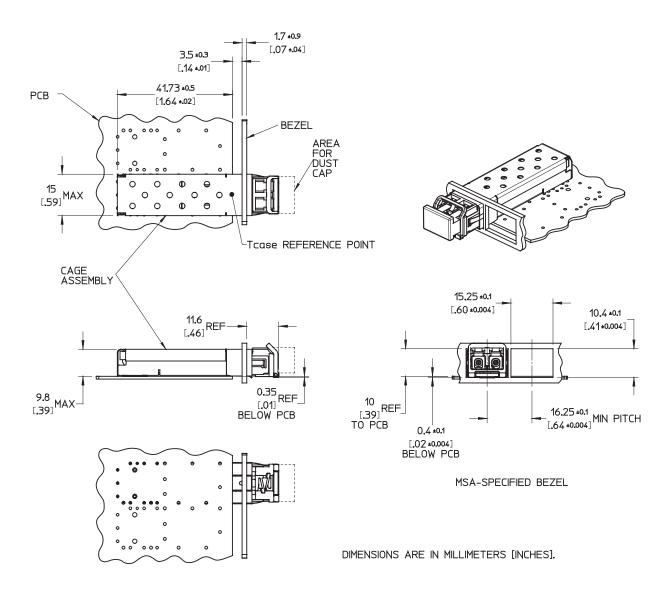


Figure 7. Assembly Drawing

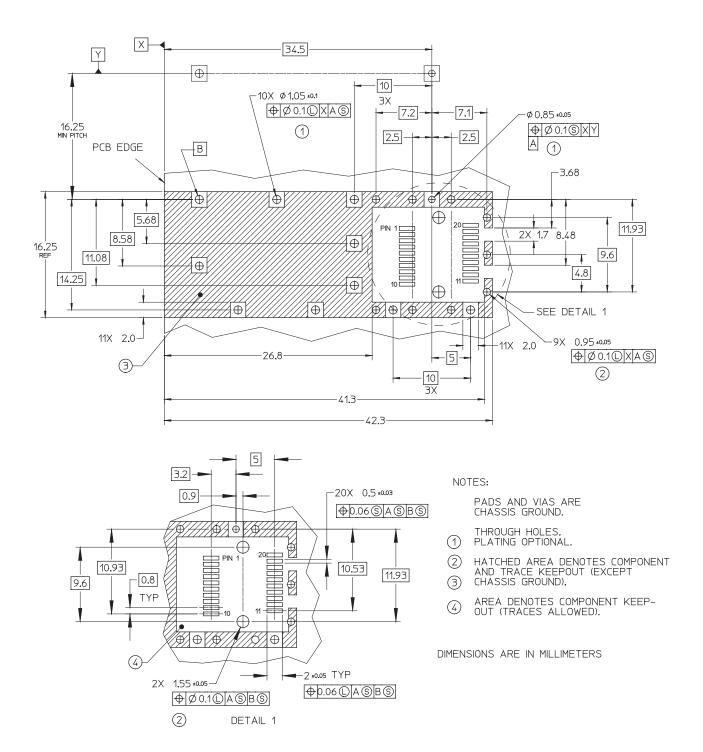


Figure 8. SFP host board mechnical layout

## **Ordering Information**

Please contact your local field sales engineer or one of Avago Technologies franchised distributors for ordering information. For technical information, please visit Avago Technologies' web-page at www.avagotech.com or contact one of Avago Technologies' regional Technical Response Centers. For information related to SFF Committee documentation, visit www.sffcommittee.org.

### 1300nm FP Laser (Operating Case Temperature -10 to +85 °C)

### With DMI

AFCT-5755LZ SR standard de-latch (2 km)

AFCT-5755PZ SR bail de-latch (2 km)

AFCT-5755TLZ IR standard de-latch (15 km)

AFCT-5755TPZ IR bail de-latch (15 km)

### Without DMI

AFCT-5750LZ SR standard de-latch (2 km)

AFCT-5750PZ SR bail de-latch (2 km)

AFCT-5750TLZ IR standard de-latch (15 km)

AFCT-5750TPZ IR bail de-latch (15 km)

## 1300nm FP Laser (Operating Case Temperature -40 to +85 °C)

#### With DMI

AFCT-5755ALZ SR standard de-latch (2 km)

AFCT-5755APZ SR bail de-latch (2 km)

AFCT-5755ATLZ IR standard de-latch (15 km)

AFCT-5755ATPZ IR bail de-latch (15 km)

### Without DMI

AFCT-5750ALZ SR standard de-latch (2 km)

AFCT-5750APZ SR bail de-latch (2 km)

AFCT-5750ATLZ IR standard de-latch (15 km)

AFCT-5750ATPZ IR bail de-latch (15 km)

### **EEPROM Content and / or Label Options**

AFCT-5750XXXX-YYY AFCT-5755XXXX-YYY

Where "XXXX" refers to product option

"YYY" is customer specific



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for foxconn manufacturer:

Other Similar products are found below:

AFBR-709DMZ JPD1030-N521-4F AFCT-5805BZ 2EGL4997-B2DM-4F AFCT-57F3ATMZ AFBR-57R6AEZ 3H993921-4M41-02H DZ11A51-H8R1-4F ABCU-5741ARZ AFCT-739ASMZ 3H993321-4M41-01H DT00151-H1A2-4F AFBR-89CEDZ UH51543-BW11-7F 2EG14917-D2D8-4F AFCT-5765ATPZ JFM38U11-B313-4F LU25683-A001-9H ABCU-5740RZ UEA11121-8FS6-4F LD1807F-S54TD UB11123-8Z4-7F AS0B226-S99Q-7H 2EG08217-D2D-DF WNMEL00-84N00-EH AFBR-5710LZ AFBR-5715APZ HM3512E-P2 DT10121-H4W2-4F ABCU-5740ARZ AFBR-5921ALZ AS0A621-HARN-7H AS0A621-HASN-7H AFBR-79EIPZ-F5 AFCT-5961ATLZ AS0A621-H2S6-7H ASAA821-EARB0-7H WQ21823-DES1-7F AS0BC21-S40BE-7H AFBR-5715PZ AFBR-59R5LZ AFBR-57R5APZ AFBR-57R6APZ UEA1112C-4HK1-4H AS0B326-S78N-7F